

Description

The NTTFS4C10N uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =80 A

 $R_{DS(ON)} < 6 \text{ m}\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

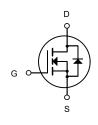
Product ID	Pack	Brand	Qty(PCS)
NTTFS4C10N	DFN3X3-8L	HXY MOSFET	5000

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	30	V
VGS	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	80	А
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	50	Α
IDM	Pulsed Drain Current ²	162	А
EAS	Single Pulse Avalanche Energy ³	144.7	mJ
IAS	Avalanche Current	53.8	А
P _D @T _C =25°C	Total Power Dissipation⁴	62.5	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _θ JA	Thermal Resistance Junction-ambient ¹	62	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	2.4	°C/W



DFN3X3-8L



N-Channel MOSFET



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.0213		V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V_{GS} =10V , I_D =30A		4.7	6	- mΩ
		V _{GS} =4.5V , I _D =15A		5.9	8	
$V_{GS(th)}$	Gate Threshold Voltage	V V I 050-A	1.0	1.5	2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-5.73		mV/°C
1	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	uA
I _{DSS}		V_{DS} =24V , V_{GS} =0V , T_J =55 $^{\circ}$ C			5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		26.5		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.4	2.8	Ω
Qg	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		31.6		
Q_{gs}	Gate-Source Charge			8.6		nC
Q_{gd}	Gate-Drain Charge			11.7		
T _{d(on)}	Turn-On Delay Time			9		ns
T _r	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		19		
T _{d(off)}	Turn-Off Delay Time			58		
T _f	Fall Time			15.2		
C _{iss}	Input Capacitance			3075	4000	
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		400	530	pF
C _{rss}	Reverse Transfer Capacitance			315		
Is	Continuous Source Current ^{1,5}	\/ -\/ -0\/ Famas Cums = t			80	Α
I _{SM}	Pulsed Source Current ^{2,5}	──V _G =V _D =0V , Force Current			162	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V
t _{rr}	Reverse Recovery Time	IF=30A , dI/dt=100A/μs ,		18		nS
Q _{rr}	Reverse Recovery Charge	T _J =25°C		8		nC

Note:

^{1.}The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

^{2.}The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

^{3.} The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS}=53.8A

^{4.} The power dissipation is limited by 175°C junction temperature

^{5.} The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

Typical Characteristics

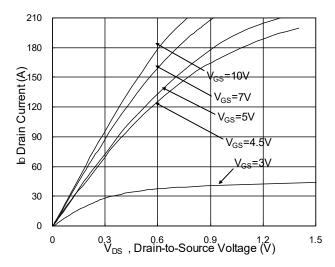


Fig.1 Typical Output Characteristics

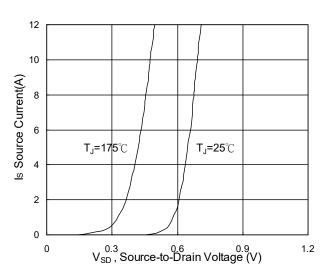


Fig.3 Forward Characteristics of Reverse

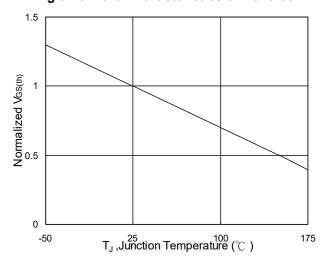


Fig.5 Normalized V_{GS(th)} vs. T_J

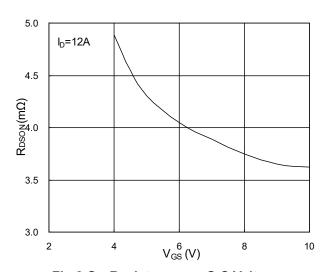


Fig.2 On-Resistance vs. G-S Voltage

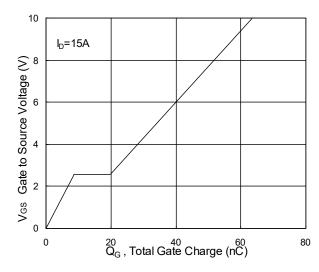


Fig.4 Gate-Charge Characteristics

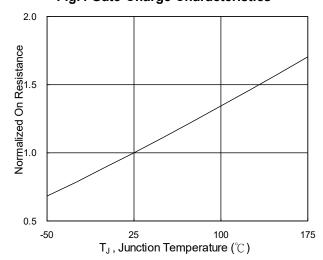
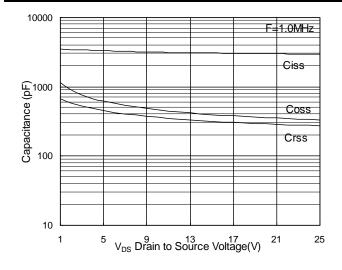


Fig.6 Normalized R_{DSON} vs. T_J



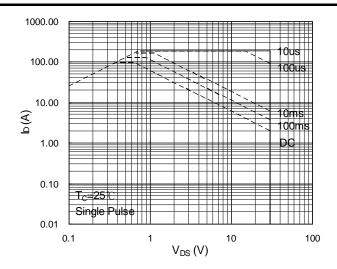


Fig.7 Capacitance

Fig.8 Safe Operating Area

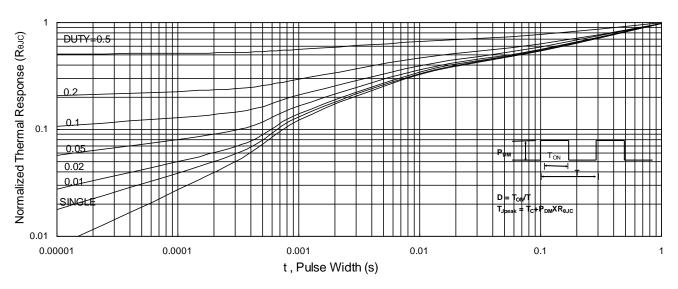


Fig.9 Normalized Maximum Transient Thermal Impedance

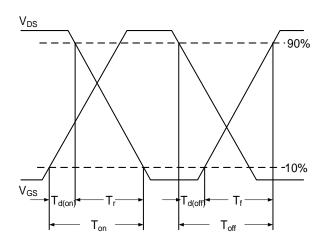


Fig.10 Switching Time Waveform

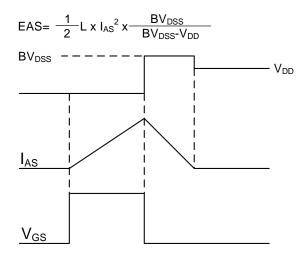
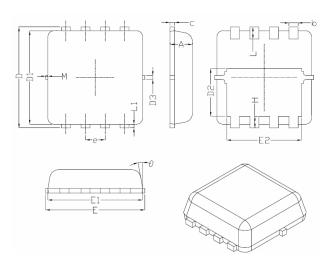


Fig.11 Unclamped Inductive Switching Waveform

DFN3X3-8L Package Information



Complete I	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е		0.65BSC		
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10°	12 [°]	



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